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MOSFET - Power, Single N-Channel, Source-Down TDFN9

60 V, 1.5 mΩ**, 235 A**

NTMFSS1D5N06CL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen-Free / BFR Free and are RoHS Compliant

Typical Applications

- DC-DC Converters
- Power Load Switch
- Notebook Battery Management

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	60	V	
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_C = 25^{\circ}C$	۱ _D	237	А
		$T_C = 100^{\circ}C$		149	
Power Dissipation	Steady State	$T_C = 25^{\circ}C$	PD	144	W
$R_{ extsf{ heta}JC}$		$T_{C} = 100^{\circ}C$		57	
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2)	Steady State	T _A = 25°C	۱ _D	31	А
		T _A = 100°C		19	
Power Dissipation	Steady State	T _A = 25°C	PD	2.5	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	1698	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +150	°C	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 75 A)		E _{AS}	207	mJ	
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)		TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

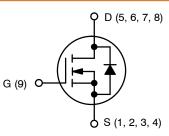
THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.86	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	50	

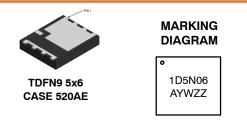
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 1 in² pad size, 2 oz. Cu pad.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.5 m Ω @ 10 V	235 A
	$2.3~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	235 A



N-CHANNEL MOSFET



1D5N06 = Specific Device Code

A = Assembly Location

Y = Year

W = Work Week ZZ = Wafer Lot

ORDERING INFORMATION

Device	Package	Shipping [†]		
NTMFSS1D5N06CL	TDFN9 (Pb-Free)	3000 / Tape & Reel		

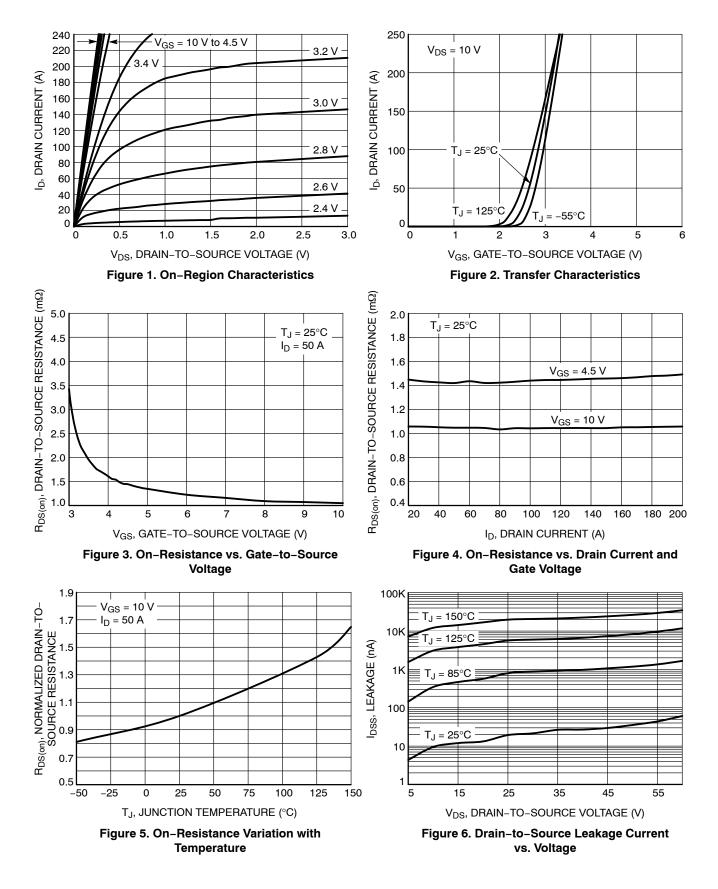
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

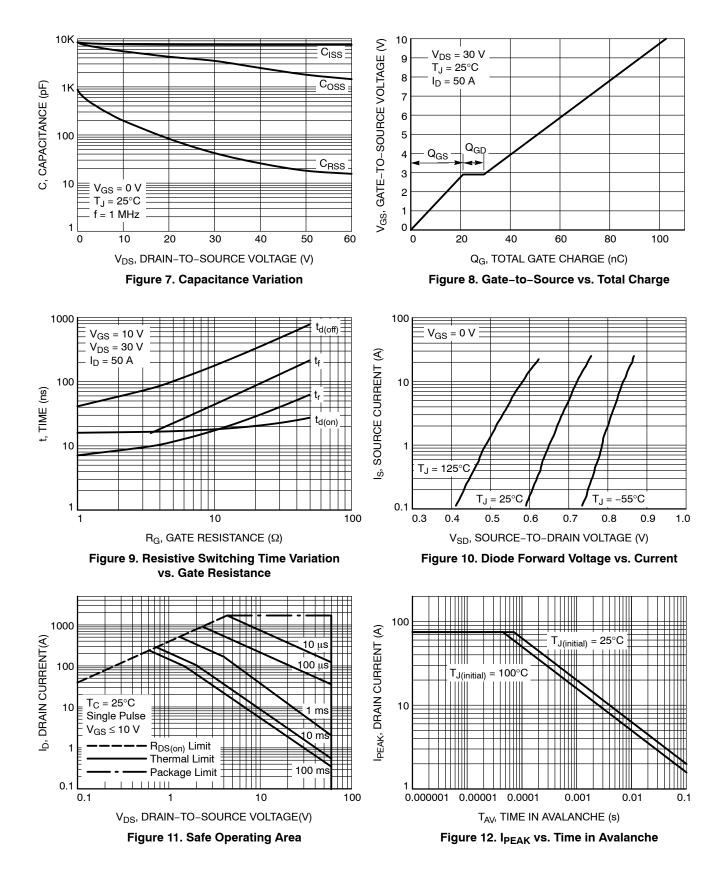
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS		•					
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /	$I_D = 250 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$			23.2		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	′ T _J = 25°C			10	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 250 μA, re	f to 25°C		-5.76		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _[_D = 50 A		1.05	1.5	mΩ
		V _{GS} = 4.5 V, I _D = 50 A			1.42	2.3	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			151		S
Gate Resistance	R _G	T _A = 25°C			1		Ω
CHARGES & CAPACITANCES		•					
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V			7526		pF
Output Capacitance	C _{OSS}				3462		
Reverse Capacitance	C _{RSS}				42		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V, I_{D} = 50 A			102.6		nC
Total Gate Charge	Q _{G(TOT)}				46.1		1
Gate-to-Drain Charge	Q _{GD}	V _{GS} = 4.5 V, V _{DS} = 30 V, I _D = 50 A			8.4		1
Gate-to-Source Charge	Q _{GS}				21		
Plateau Voltage	V _{GP}				2.9		V
SWITCHING CHARACTERISTICS (Note	3)						
Turn-On Delay Time	t _{d(ON)}				16		ns
Rise Time	t _r	Vcs = 4.5 V. Vc	n = 30 V.		7.1		
Turn–Off Delay Time	t _{d(OFF)}	$\begin{array}{l} V_{GS}=\text{4.5 V}, V_{DD}=\text{30 V},\\ I_{D}=\text{50 A}, R_{G}=\text{1.0 }\Omega \end{array}$			41.3		
Fall Time	t _f				5.4		
SOURCE-TO-DRAIN DIODE CHARACT	ERISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 50 A$	$T_J = 25^{\circ}C$		0.78	1.2	V
			T _J = 125°C		0.66		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dl/dt = 100 A/μs, I _S = 50 A			83		ns
Charge Time	t _a				39.9		1
Discharge Time	t _b				43.2		
Reverse Recovery Charge	Q _{RR}				142	l	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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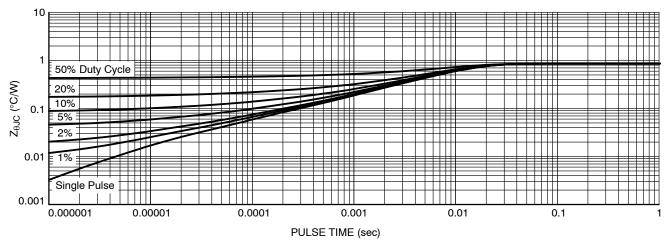
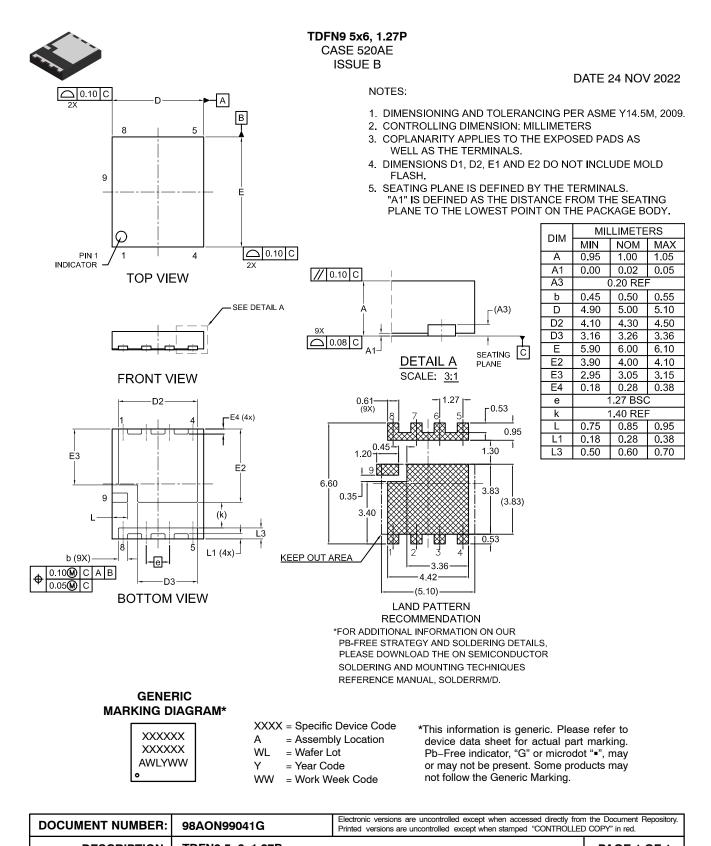


Figure 13. Thermal Characteristics

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DESCRIPTION: TDFN9 5x6, 1.27P PAGE 1 OF 1
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